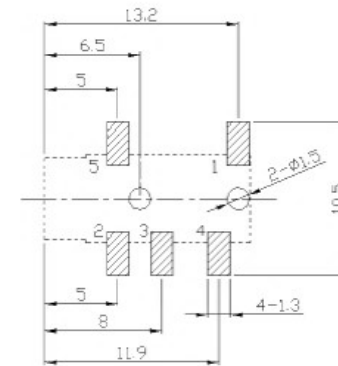
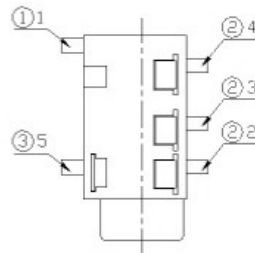
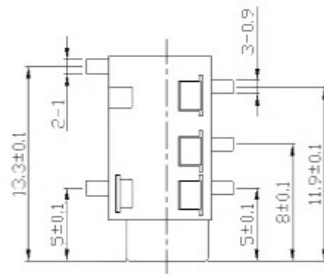
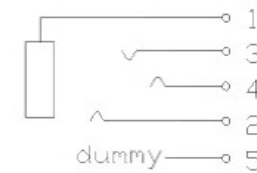
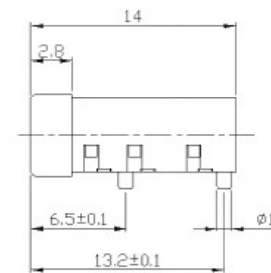
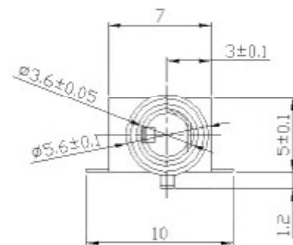




PCB LAYOUT



CIRCUIT DIAGRAM



	MATERIAL	PLATING
terminal 1	copper all oy	silver
terminal 2	copper all oy	silver
terminal 3	copper all oy	silver
terminal 4	copper all oy	silver
plastic	PA10T	

DSND		DATE		SCALE: N/A	MODEL TYPE: 3.5 PHONE JACK
DWN		DATE		VIEW:	PART NO.:
CHKD		DATE		UNIT: mm	DWG NO.:
APPD		DATE		SIZE: A4	
东莞市溪榜电子有限公司					WEIGHT 1.0g
					SHEET 1/1
					REVISION A0

MARK	DESCRIPTION	DATE	REVISED	APPROVED	ANGLAR	±5°
△ X					L ≤ 4	±0.2
△ X					4 < L ≤ 16	±0.3
△ X					16 < L ≤ 63	±0.4
MARK					L > 63	±0.5
REVISIONS					UNSPECIFIED TOLERANCES	